PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

EPAS ID: PAT6920439

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
AKIHITO OTSUKA	08/16/2021
TAKASHI KASHIWABARA	08/16/2021
KAZUNORI AOKI	08/16/2021
TAKESHI KUMANO	08/16/2021

RECEIVING PARTY DATA

Name:	SHIKOKU CHEMICALS CORPORATION
Street Address:	8-537-1, DOKI-CHO HIGASHI, MARUGAME-SHI
City:	KAGAWA
State/Country:	JAPAN
Postal Code:	7638504

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17440084

CORRESPONDENCE DATA

Fax Number: (703)935-8473

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 5713137556 Email: mail@paratus.law

PARATUS LAW GROUP, PLLC **Correspondent Name:**

1765 GREENSBORO STATION PLACE Address Line 1:

Address Line 2: SUITE 320

Address Line 4: TYSONS CORNER, VIRGINIA 22102

ATTORNEY DOCKET NUMBER:	08-604-0001
NAME OF SUBMITTER:	MIHARU SCULLY
SIGNATURE:	/Miharu Scully/
DATE SIGNED:	09/16/2021
	This document serves as an Oath/Declaration (37 CFR 1.63).

Total Attachments: 4

PATENT REEL: 057505 FRAME: 0280

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> PATENT REEL: 057505 FRAME: 0281

DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT FOR SINGLE ASSIGNEE

Title of Invention	RESIN COMPOSITION AND USE THEREOF
As the below	named inventor, I hereby declare that:
This declarati	The attrobad and bather as
	United States application or PCT international application number PCT/JP2020/013568 filed on March 26, 2020
The above-id	entified application was made or authorized to be made by me.
WHEREAS,	
is desirous o	Doki-cho Higashi, Marugame-shi, Kagawa 7638504, Japan (hereinafter referred to as ASSIGNEE), f acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters lar legal protection which may be granted therefor in the United States and in any and all foreign countries;
NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I by these presents do hereby assign, sell and transfer unto said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property. Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filling of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;	
And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;	
And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as said ASSIGNEE thereof shall hereafter require and prepare at its own expense;	
And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;	
And I hereby this assignmen	covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with at and sale.
	owledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of five (5) years, or both.
LEGAL NAM	E OF INVENTOR
Inventor:	Akihito OTSUKA Date: /August 6, 2021
Signature:	1) Oteka

Paratus Law Group, PLLC
1765 Greensboro Station Piace, Suite 320
Tysons Corner. VA 22102
Tel: (571) 313-7556 | Fax: (703) 935-8473

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WHEREAS,	I am the original inventor or an original joint inventor of a claimed invention in the application. SHIKOKU CHEMICALS CORPORATION, with offices at
	Doki-cho Higashi, Marugame-shi, Kagawa 7638504, Japan (hereinafter referred to as ASSIGNEE),
is desirous o Patent or simi	f acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters lar legal protection which may be granted therefor in the United States and in any and all foreign countries;
of which are I representative to any and all all priority r. Convention I adheres, and United States Patent to said	EFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency tereby acknowledged, I by these presents do hereby assign, sell and transfer unto said ASSIGNEE, its successors, assigns, and legal is, the entire right, title and interest in said invention, said application, including any divisions and continuations thereof, and in and Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and ights and/or convention rights under the International Convention for the Protection of Industrial Property. Inter-American telating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America to any other henefits accruing or to accrue to me with respect to the filling of applications for patents or securing of patents in the and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue said United States Letters ASSIGNEE, as the assignce of the whole right, title and interest thereto;
designee, as remuneration	agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the and countries foreign thereto;
And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as said ASSIGNEE thereof shall hereafter require and prepare at its own expense;	
And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;	
And I hereby this assignme	covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with nt and sale.
	owledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of five (5) years, or both.
LEGAL NAM	ME OF INVENTOR
Inventor:	Takashi KASHIWABARA Date: August 16, 2021
Cionatrea	Takashi KASHINABARA

Paratus Law Group, PLLC 1765 Greensboro Station Place, Suite 320 Tysons Corner, VA 22102 Tel: (571) 313-7556 | Fax: (703) 935-8473

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is desirous o	f acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters lar legal protection which may be granted therefor in the United States and in any and all foreign countries;
NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I by these presents do hereby assign, sell and transfer unto said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue said United States Letters Patent to said ASSIGNEE, as the assignce of the whole right, title and interest thereto;	
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And I hereby this assignmen	covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with and sale.
	owledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of five (5) years, or both.
LEGAL NAV	IE OF INVENTOR
Inventor.	Kazunori AOKI Kazumeni Quki Date: August 16/202/
Signature	

Paratus Law Group, PLLC 1765 Greensboro Station Place, Suite 320 Tysons Corner, VA 22102 Tel: (671) 313-7556 | Fax: (703) 935-8473

RECORDED: 09/16/2021

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This declaration is directed to:	The attached application, or
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NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I by these presents do hereby assign, sell and transfer unto said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other henefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue said United States Letters Patent to said ASSIGNEE, as the assignce of the whole right, title and interest thereto;	
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LEGAL NAN	IE OF INVENTOR
Inventor:	Takeshi KUMANO Date: August, 16, 202
Signature:	5. Vinney

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